

2SD2240, 2SD2240A

Silicon NPN epitaxial planer type

For high breakdown voltage low-frequency and low-noise amplification

Features

- High collector to emitter voltage V_{CEO} .
- Low noise voltage NV.
- SS-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing.

Absolute Maximum Ratings (Ta=25°C)

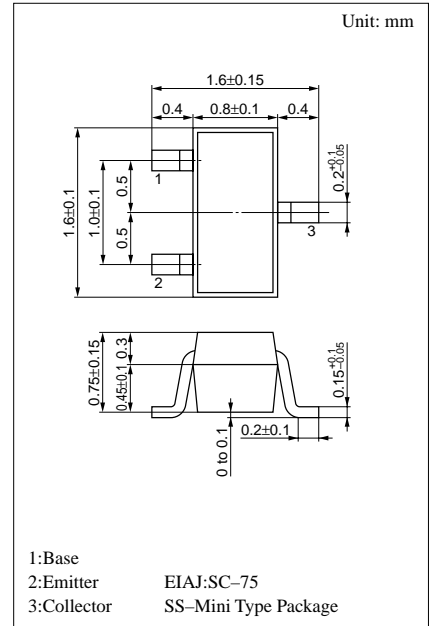
Parameter	Symbol	Ratings	Unit
Collector to base voltage	2SD2240 2SD2240A	V_{CBO}	V
Collector to emitter voltage			
Emitter to base voltage	V_{EBO}	5	V
Peak collector current	I_{CP}	100	mA
Collector current	I_C	50	mA
Collector power dissipation	P_C	125	mW
Junction temperature	T_j	125	°C
Storage temperature	T_{stg}	-55 ~ +125	°C

Electrical Characteristics (Ta=25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = 100V, I_E = 0$			1	μA
Collector to emitter voltage	2SD2240 2SD2240A	V_{CEO}	$I_C = 100\mu A, I_B = 0$			V
Emitter to base voltage						
Forward current transfer ratio	h_{FE}^*	$V_{CE} = 5V, I_C = 10mA$	130		330	
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = 30mA, I_B = 3mA$			1	V
Transition frequency	f_T	$V_{CB} = 10V, I_E = -10mA, f = 200MHz$		150		MHz
Collector output capacitance	C_{ob}	$V_{CB} = 10V, I_E = 0, f = 1MHz$		2.3		pF
Noise voltage	NV	$V_{CE} = 10V, I_C = 1mA, G_V = 80dB$ $R_g = 100k\Omega, \text{Function} = \text{FLAT}$		150		mV

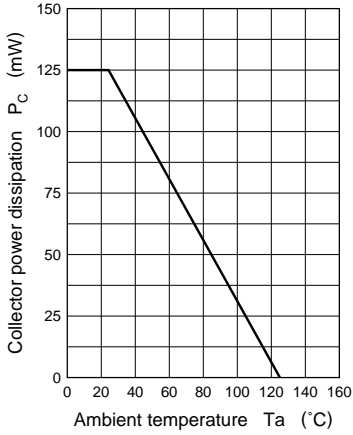
* h_{FE1} Rank classification

Rank	R	S
h_{FE}	130 ~ 220	185 ~ 330
Marking Symbol	2SD2240 PR	2SD2240A PS
	LR	LS

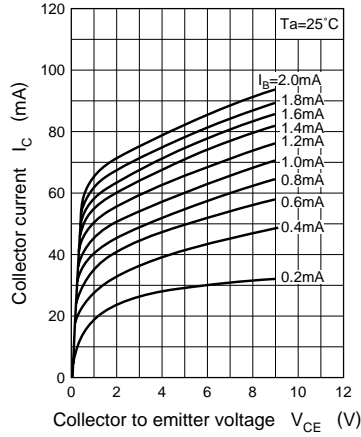


Marking symbol : P(2SD2240)
L(2SD2240A)

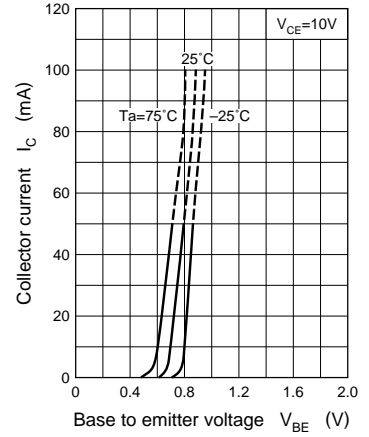
$P_C - T_a$



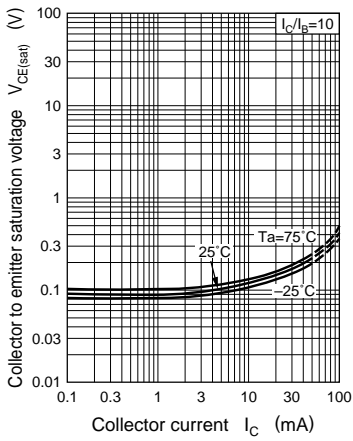
$I_C - V_{CE}$



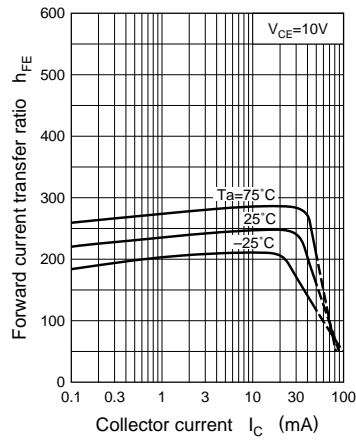
$I_C - V_{BE}$



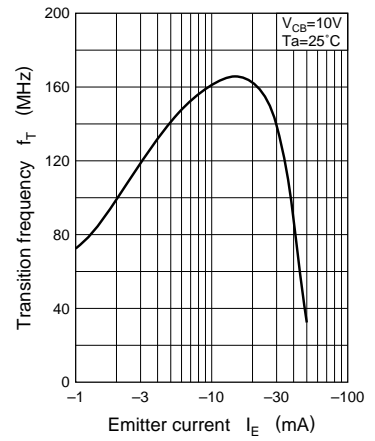
$V_{CE(sat)} - I_C$



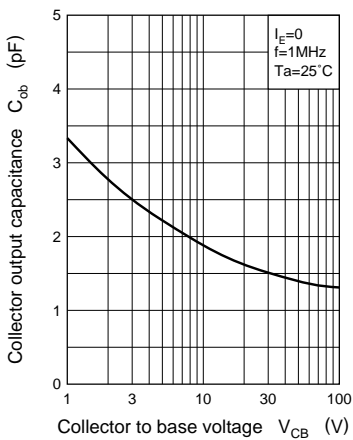
$h_{FE} - I_C$



$f_T - I_E$



$C_{ob} - V_{CB}$



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